NPN 100mA 50V Digital Transistor (Bias Resistor Built-in Transistor)

Datasheet

#### **AEC-Q101 Qualified**

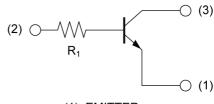
Parameter	Value	
V <sub>CEO</sub>	50V	
I <sub>C</sub>	100mA	
$R_1$	4.7kΩ	

# Outline SOT-23 (SST3)

#### Features

- 1) Built-In Biasing Resistor
- 2) Built-in bias resistors enable the configuration of an inverter circuit without connecting external input resistors (see inner circuit).
- 3) Only the on/off conditions need to be set for operation, making the circuit design easy.
- 4) Complementary PNP Types: DTA143TCA HZG

#### •Inner circuit



- (1) EMITTER
- (2) BASE
- (3) COLLECTOR

#### Application

INVERTER, INTERFACE, DRIVER

#### Packaging specifications

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
DTC143TCA HZG	SOT-23 (SST3)	2924	T116	180	8	3000	03

## ● Absolute maximum ratings (T<sub>a</sub> = 25°C)

Parameter	Symbol	Values	Unit
Collector-base voltage	$V_{CBO}$	50	V
Collector-emitter voltage	V <sub>CEO</sub>	50	V
Emitter-base voltage	V <sub>EBO</sub>	5	V
Collector current	I <sub>C</sub>	100	mA
Device discipation	P <sub>D</sub> *1	200	mW
Power dissipation	P <sub>D</sub> *2	350	mW
Junction temperature	Tj	150	°C
Range of storage temperature	T <sub>stg</sub>	-55 to +150	°C

## ● Electrical characteristics (T<sub>a</sub> = 25°C)

Parameter	Cumbal	Conditions	Values			Unit	
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Or ill	
Collector-base breakdown voltage	BV <sub>CBO</sub>	$BV_{CBO}$ $I_C = 50\mu A$		1	1	V	
Collector-emitter breakdown voltage	BV <sub>CEO</sub> I <sub>C</sub> = 1mA		50	-	-	V	
Emitter-base breakdown voltage	BV <sub>EBO</sub>	I <sub>E</sub> = 50μA	5	1	1	٧	
Collector cut-off current	I <sub>CBO</sub>	V <sub>CB</sub> = 50V	1	1	500	nA	
Emitter cut-off current	I <sub>EBO</sub>	V <sub>EB</sub> = 4V	1	1	500	nA	
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	$I_C = 5mA, I_B = 0.25mA$	1	1	300	mV	
DC current gain	h <sub>FE</sub>	$V_{CE} = 5V$ , $I_{C} = 1mA$	100	250	600	-	
Input resistance	R <sub>1</sub>	-	3.29	4.7	6.11	kΩ	
Transition frequency	f <sub>T</sub> *3	V <sub>CE</sub> = 10V, I <sub>E</sub> = -5mA, f = 100MHz	-	250	1	MHz	

<sup>\*1</sup> Each terminal mounted on a reference land.

<sup>\*2</sup> Mounted on a ceramic board(7.0×5.0×0.6mm).

<sup>\*3</sup> Characteristics of built-in transistor

### ● Electrical characteristic curves (T<sub>a</sub> =25°C)

Fig.1 Grounded emitter propagation characteristics

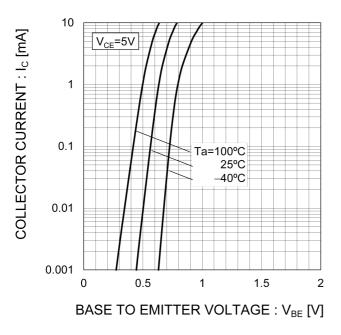


Fig.2 Grounded emitter output characteristics

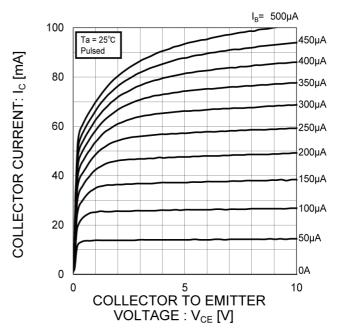


Fig.3 DC Current gain vs. Collector Current

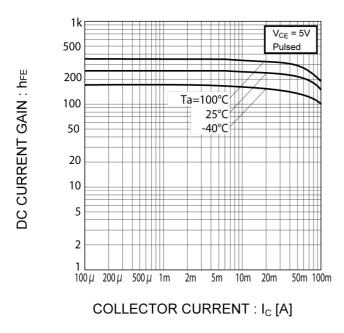
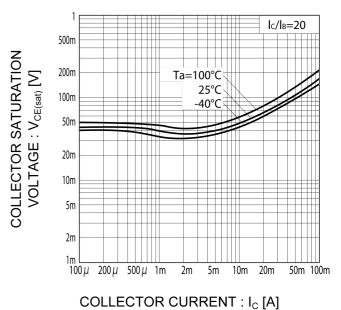
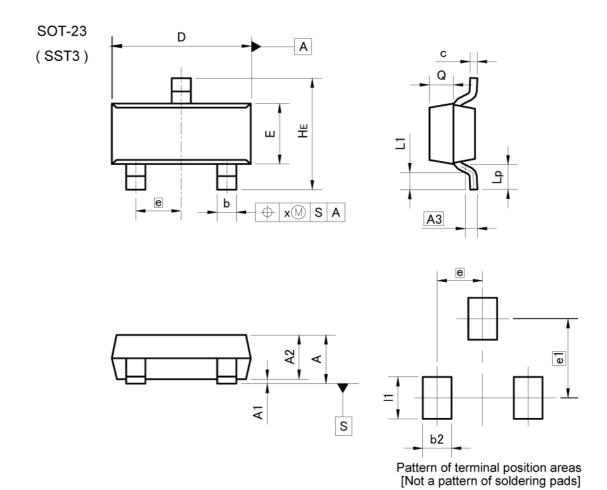


Fig.4 Collector-emitter saturation voltage vs. Collector Current



#### Dimensions



DIM	MILIMETERS		INCHES		
DIM	MIN	MAX	MIN	MAX	
Α	0.90	1.20	0.035	0.047	
A1	0.00	0.10	0.000	0.004	
A2	0.85	1.15	0.033	0.045	
A3	0.3	25	0.0	10	
b	0.35	0.50	0.014	0.020	
С	0.09	0.25	0.004	0.010	
D	2.70	3.10	0.106	0.122	
E	1.20	1.50	0.047	0.059	
е	0.9	95 0.		037	
HE	2.20	2.60	0.087	0.102	
L1	0.20	00	0.008	_	
Lp	0.30	2,-3	0.012	-	
Q	0.40	0.60	0.016	0.024	
х	- ,,	0.10	e <del></del>	0.004	

DIM	MILIMETERS		INCHES		
DIM	MIN	MAX	MIN	MAX	
b2	- 0.60		- 0.024		
e1	1.70		0.067		
- 11	- 0.90		-	0.035	

Dimension in mm/inches



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(Note1) Medical Equipment Classification of the Specific Applications

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	CLASSIII	CLASSIII	CLASS II b	СГУССШ
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  - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
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- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

#### **Precaution for Storage / Transportation**

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
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  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
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  exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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